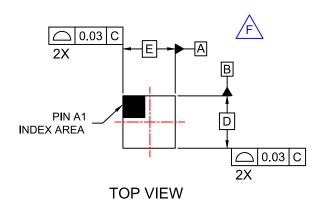
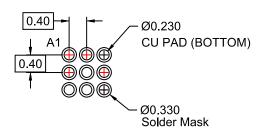


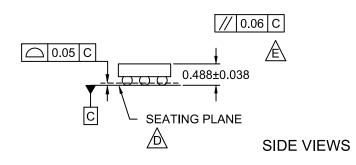
WLCSP9 1.26x1.215x0.526 CASE 567TN ISSUE O

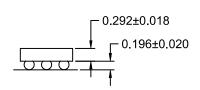
DATE 31 MAR 2017

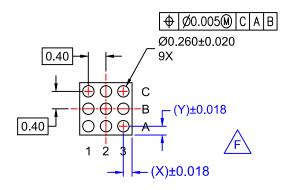




LAND PATTERN RECOMMENDATION (NSMD PAD TYPE)







BOTTOM VIEW

NOTES:

- A. NO JEDEC REGISTRATION APPLIES.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCE PER ASME Y14.5M, 2009.

DATUM C IS DEFINED BY THE SPHERICAL CROWNS OF THE BALLS.

E. PACKAGE NOMINAL HEIGHT IS 488 MICRONS ±38 MICRONS (450-526 MICRONS).

FOR DIMENSIONS D, E, X, AND Y SEE PRODUCT DATASHEET.

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DESCRIPTION:	WLCSP9 1.26x1.215x0.526		PAGE 1 OF 1

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